# Old Company Name in Catalogs and Other Documents

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# FS30KMJ-3

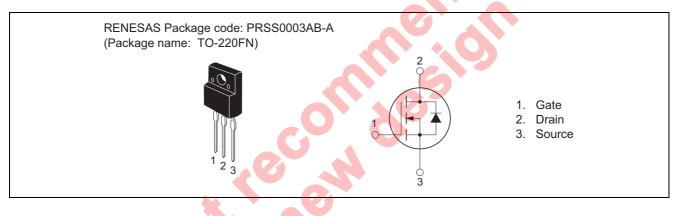
High-Speed Switching Use Nch Power MOS FET

REJ03G1415-0200 (Previous: MEJ02G0080-0101) Rev.2.00 Aug 07, 2006

# Features

- Drive voltage : 4 V
- V<sub>DSS</sub> : 150 V
- $r_{\text{DS(ON)}(\text{max})}$ : 86 m $\Omega$
- I<sub>D</sub>: 30 A
- Integrated Fast Recovery Diode (TYP.): 100 ns
- Viso : 2000 V

## Outline



# Applications

Motor control, Lamp control, Solenoid control, DC-DC converters, etc.

# **Maximum Ratings**

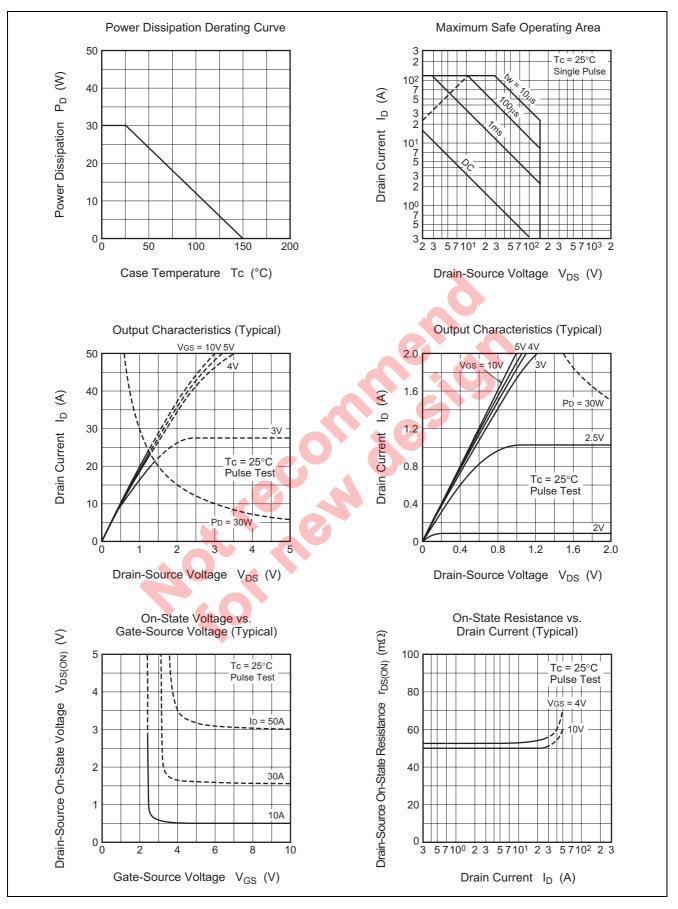
	•			$(Tc = 25^{\circ}C)$	
Parameter	Symbol	Ratings	Unit	Conditions	
Drain-source voltage	V <sub>DSS</sub>	150	V	$V_{GS} = 0 V$	
Gate-source voltage	V <sub>GSS</sub>	±20	V	$V_{DS} = 0 V$	
Drain current	ID	30	A		
Drain current (Pulsed)	I <sub>DM</sub>	120	A		
Avalanche drain current (Pulsed)	I <sub>DA</sub>	30	A	L = 100 μH	
Source current	Is	30	A		
Source current (Pulsed)	I <sub>SM</sub>	120	A		
Maximum power dissipation	PD	30	W		
Channel temperature	Tch	- 55 to +150	°C		
Storage temperature	Tstg	- 55 to +150	°C		
Isolation voltage	Viso	2000	V	AC for 1 minute, Terminal to case	
Mass	—	2.0	g	Typical value	



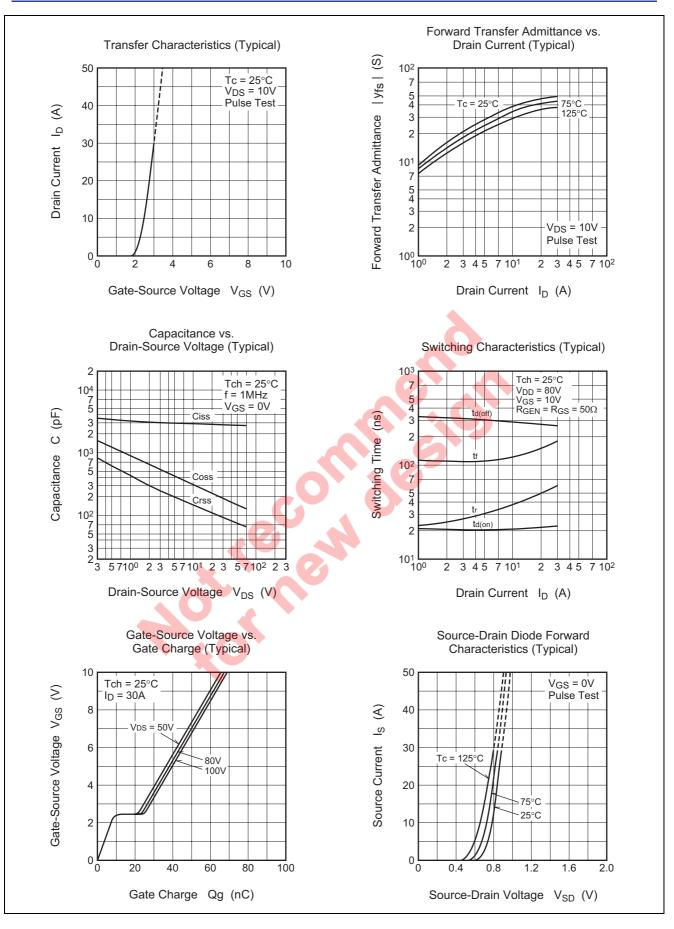
# **Electrical Characteristics**

						$(Tch = 25^{\circ}C)$
Parameter	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	150	—	—	V	$I_D = 1 \text{ mA}, V_{GS} = 0 \text{ V}$
Gate-source leakage current	I <sub>GSS</sub>		_	±0.1	μΑ	$V_{GS} = \pm 20 \text{ V},  V_{DS} = 0 \text{ V}$
Drain-source leakage current	I <sub>DSS</sub>		—	0.1	mA	$V_{DS} = 150 \text{ V}, V_{GS} = 0 \text{ V}$
Gate-source threshold voltage	V <sub>GS(th)</sub>	1.0	1.5	2.0	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Drain-source on-state resistance	r <sub>DS(ON)</sub>		66	86	mΩ	$I_D = 15 \text{ A}, V_{GS} = 10 \text{ V}$
Drain-source on-state resistance	r <sub>DS(ON)</sub>		69	90	mΩ	$I_D = 15 \text{ A}, V_{GS} = 4 \text{ V}$
Drain-source on-state voltage	V <sub>DS(ON)</sub>		0.99	1.29	V	$I_D = 15 \text{ A}, V_{GS} = 10 \text{ V}$
Forward transfer admittance	y <sub>fs</sub>		38	—	S	$I_D = 15 \text{ A}, V_{DS} = 10 \text{ V}$
Input capacitance	Ciss		3000	—	рF	$V_{DS} = 10 V, V_{GS} = 0 V,$
Output capacitance	Coss		320	—	pF	f = 1MHz
Reverse transfer capacitance	Crss	_	160	—	pF	
Turn-on delay time	t <sub>d(on)</sub>	—	22	—	ns	$V_{DD} = 80 V, I_D = 15 A,$
Rise time	tr	—	42	—	ns	$V_{GS} = 10 V,$
Turn-off delay time	t <sub>d(off)</sub>	—	280	—	ns	$R_{GEN} = R_{GS} = 50 \ \Omega$
Fall time	t <sub>f</sub>	—	130	—	ns	
Source-drain voltage	$V_{SD}$	—	1.0	1.5	V	$I_{S} = 15 \text{ A}, V_{GS} = 0 \text{ V}$
Thermal resistance	R <sub>th(ch-c)</sub>	—	—	4.17	°C/W	Channel to case
Reverse recovery time	t <sub>rr</sub>	_	100		ns	$I_{S} = 30 \text{ A}, d_{is}/d_{t} = -100 \text{ A}/\mu \text{s}$

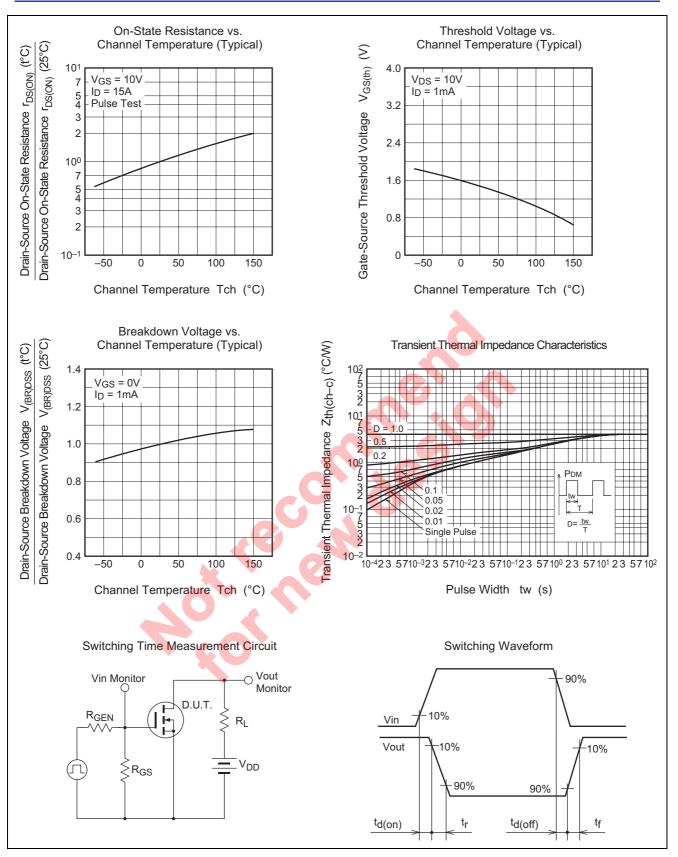
# **Performance Curves**



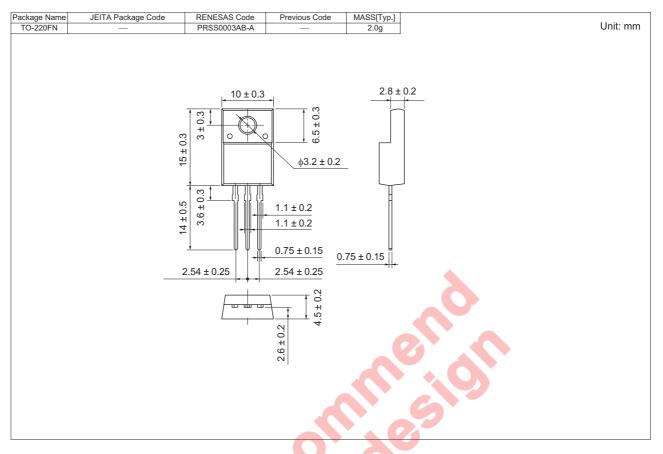








# **Package Dimensions**



## **Order Code**

Lead form	Standard packing	Quantity	Standard order code	Standard order code example
Straight type	Plastic Magazine (Tube)	50	Type name	FS30KMJ-3
Lead form	Plastic Magazine (Tube)	50	Type name – Lead forming code	FS30KMJ-3-A8

Note : Please confirm the specification about the shipping in detail.

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